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Introduction

The increasing demand for energy and environmental protection has stimulated intensive research into energy storage and conversion from alternative energy sources. Currently, the supercapacitor is one of the most ideal candidates for green energy storage because of its high power density, super-high cycling life and safe operation.¹⁻³ Based on the charge–storage mechanism, supercapacitors are generally divided into two types: electrical double-layer capacitors (EDLCs) that use carbon-active

One-step synthesis of Ni₃S₂ nanorod@Ni(OH)₂ nanosheet core–shell nanostructures on a threedimensional graphene network for high-performance supercapacitors[†]

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A three-dimensional graphene network (3DGN) grown on nickel foam is an excellent template for the synthesis of graphene-based composite electrodes for use in supercapacitors. Ni(OH)₂ nanosheets coated onto single-crystal Ni₃S₂ nanorods grown on the surface of the 3DGN (referred to as the Ni₃S₂@Ni(OH)₂/3DGN) are synthesized using a one-step hydrothermal reaction. SEM, TEM, XRD and Raman spectroscopy are used to investigate the morphological and structural evolution of the Ni₃S₂@Ni(OH)₂/3DGN. Detailed electrochemical characterization shows that the Ni₃S₂@Ni(OH)₂/3DGN exhibits high specific capacitance (1277 F g⁻¹ at 2 mV s⁻¹ and 1037.5 F g⁻¹ at 5.1 A g⁻¹) and areal capacitance (4.7 F cm⁻² at 2 mV s⁻¹ and 3.85 F cm⁻² at 19.1 mA cm⁻²) with good cycling performance (99.1% capacitance retention after 2000 cycles).

materials and pseudocapacitors that use redox-active materials. Among the numerous pseudocapacitor materials, transition metal oxides and hydroxides have been found to be excellent active materials, because of the variety of oxidation states they possess for charge transfer.⁴⁻⁸ Nickel hydroxide is an especially attractive candidate for pseudocapacitors due to its layered structure, with large interlayer spacing and high theoretical specific capacitance.⁹⁻¹¹ However, these types of pseudocapacitors are often confronted with a compromised rate capability and reversibility, which rely on the Faradic redox reaction. Recently, metal sulfides, another kind of active material, have attracted increasing interest due to their good performance in energy storage applications¹²⁻¹⁵ including supercapacitors.^{13,15}

Two-dimensional (2D) graphene has attracted much attention due to its high surface area, high flexibility and electrical conductivity.^{16–19} Graphene and graphene-based materials are widely used in electrochemical applications,²⁰ such as in graphene-based supercapacitors which have high specific capacitance.^{21–23} Since three-dimensional (3D) nanostructures with a short path for ion diffusion and large surface area provide more efficient contact between the ions of the electrolyte and the active materials, they are seen as promising electrode materials. For example, various 3D hybrid nanostructures, such as Co_3O_4 @MnO₂, CoO@NiHON and MnO₂–NiO, have been used to significantly enhance both the capacitance and durability of supercapacitors.^{6,9,24}

Recently, a novel 3D graphene network (3DGN) with an enlarged void volume, large surface area and high electrical conductivity was reported.^{25,26} Our previous work showed that the 3DGN grown on nickel foam is an excellent template for a

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[†] Electronic supplementary information (ESI) available: Calculation methods for the specific capacitance and areal capacitance of the composite electrodes prepared, photos and SEM images of the Ni₃S₂@Ni(OH)₂/3DGN after the removal of Ni₃S₂@Ni(OH)₂ and Ni foam, TEM images of the Ni(OH)₂ nanosheets and Ni₃S₂@Ni(OH)₂ after cycling, SEM images of the untreated 3DGN and Ni₃S₂@Ni(OH)₂/Ni, electrochemical characterizations of Ni₃S₂/Ni, Ni₃S₂@Ni(OH)₂/Ni and Ni(OH)₂/Ni, the calculated specific capacitance and areal capacitance data for the Ni₃S₂@Ni(OH)₂/3DGN, and the Ragone plot of energy density (*E*) versus power density (*P*) of the Ni₃S₂@Ni(OH)₂/3DGN electrode are provided in Fig. S1–S7. See DOI: 10.1039/c3ee40155c

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graphene-based composite electrode, which opened up a promising new strategy for the application of graphene-based materials in supercapacitors.^{25,27} Herein, we report the growth of a novel 3D hybrid structure, *i.e.* a Ni₃S₂ nanorod@Ni(OH)₂ nanosheet core–shell nanostructure grown on a 3DGN on nickel foam, referred to as a Ni₃S₂@Ni(OH)₂/3DGN, which has robust hierarchical porosity and a high specific surface area, using a simple one-step hydrothermal reaction. The composite and nanostructure of Ni₃S₂@Ni(OH)₂/3DGN can be controlled by varying the reaction time and the mass ratio of Ni foam to thioacetamide (TAA). Electrochemical measurements of this novel hybrid structure exhibited a high capacitance and good cycling performance.

Experimental section

Growth of the Ni₃S₂@Ni(OH)₂/3DGN hybrid structure

After the three-dimensional graphene network (3DGN) was grown on a nickel foam,25 Ni₃S₂@Ni(OH)₂/3DGN heterostructures were prepared using a simple one-step hydrothermal process. In a typical experiment, a piece of 3DGN on nickel foam was wrapped in Teflon tape with exposure area of $\sim 1 \text{ cm}^2$, and immersed into a Teflon-lined stainless steel autoclave containing a 20 mL homogeneous solution of 25 mg thioacetamide (TAA, C_2H_5NS). The autoclave was then sealed for and the hydrothermal reaction was conducted at 180 °C for 6, 12 and 24 h in order to obtain Ni₃S₂/3DGN, Ni₃S₂@Ni(OH)₂/3DGN and Ni(OH)₂/3DGN, respectively. After the autoclave was cooled down to room temperature, the samples were rinsed with a copious amount of distilled water and then dried in an electric oven at 60 °C for 12 h. As a control experiment, the nickel foam without 3DGN was used to synthesize a Ni₃S₂ nanorod@Ni(OH)2 nanosheet/nickel foam heterostructure, referred to as Ni_3S_2 (OH)₂/Ni, at 180 °C for 12 h.

Characterization

Field emission scanning electron microscopy (FESEM, Model JSM-7600F, JEOL Ltd., Tokyo, Japan) was used to characterize the morphologies of the synthesized samples. Transmission electron microscopy (TEM) images were taken using a JOEL JEM 2100F microscope. The chemical composition was investigated by using energy dispersive X-ray spectroscopy (EDX). The X-ray powder diffraction (XRD) pattern of each sample was recorded on a Bruke D8 Advance powder X-ray diffractometer using Cu K α radiation ($\lambda = 0.15406$ nm). Raman spectra were collected with a WITEC CRM200 Raman System (488 nm laser, 2.54 eV, WITec, Germany).

Electrochemical measurement

Cyclic voltammetry (CV) and galvanostatic charge–discharge were performed using a conventional three-electrode cell with 3 M KOH aqueous solution as the electrolyte and recorded on Solartron analytical equipment (Model 1470E, AMETEK, UK). The electrochemical impedance spectroscopy (EIS) test was performed using a conventional three-electrode system (CHI 660C, CH Instrument Inc., USA). The Ni₃S₂@Ni(OH)₂/3DGN on

Ni foam substrate (1 cm^2), Ag/AgCl electrode (saturated KCl) and Pt wire were used as the working, reference and counter electrodes, respectively.

Results and discussion

SEM images of the obtained Ni₃S₂@Ni(OH)₂/3DGN (see the Experimental section for details) are shown in Fig. 1a-c. The 3DGN is covered by Ni₃S₂ nanorods with a diameter of 0.5-1 µm and a length of 5-10 µm, which grew densely and almost vertically on the surface of the 3DGN. Magnified SEM images reveal that the Ni₃S₂ nanorods are covered by Ni(OH)₂ nanosheets (Fig. 1c). With such a unique hierarchical structure, the space between the Ni_3S_2 nanorods in the array can be efficiently utilized, allowing the electrolyte ions easier access to the surface of the active material. The XRD spectrum of the as-grown Ni_3S_2 (OH)₂/3DGN (Fig. 1d) shows peaks at $2\theta = 21.7, 31.1,$ 37.8, 49.7 and 55.2°, which correspond to the single crystalline Ni_3S_2 (JCPDS no. 44-1418). It should be noted that two characteristic peaks for Ni at $2\theta = 44.5$ and 51.8° in the XRD pattern arise from the Ni foam substrate (JCPDS no. 65-2865). A very small amount of NiS (JCPDS no. 21-0041) is also observed in the XRD pattern. While the presence of the Ni(OH)₂ nanosheets was not confirmed by the XRD pattern, possibly due to there only being a tiny amount, it was confirmed from the HRTEM images and EDX (Fig. 2).

The nanostructures of the Ni(OH)₂ nanosheets and Ni₃S₂ nanorods were further investigated using TEM. Fig. 2a shows the typical TEM image of an individual Ni₃S₂ nanorod covered by thin Ni(OH)₂ nanosheets. The HRTEM image obtained from the white square area labelled (b) in Fig. 2a has a lattice spacing of 0.28 nm in the backbone area of the Ni₃S₂ nanorod (Fig. 2b), which corresponds to the (110) interplanar spacing of Ni₃S₂



Fig. 1 (a) SEM image of $Ni_3S_2@Ni(OH)_2/3DGN$ (reaction time: 12 h). (b and c) The magnified SEM images of (a). (d) XRD pattern of $Ni_3S_2@Ni(OH)_2/3DGN$.



Fig. 2 (a) TEM image of Ni₃S₂@Ni(OH)₂. (b and c) HRTEM images of Ni₃S₂ nanorods and Ni(OH)₂ nanosheets from the white square areas highlighted in (a). (d) The corresponding SAED patterns of Ni₃S₂ and Ni(OH)₂. (e and f) EDS spectrum and mapping results from a single hybrid nanostructure, conforming to the Ni₃S₂@Ni(OH)₂ core–shell hierarchical structure.

(hexagonal, a = b = 0.574 nm, c = 0.714 nm). The lattice distances of 0.27 and 0.23 nm in Fig. 2c correspond to the (011) and (100) faces of Ni(OH)₂ (hexagonal, a = b = 0.312 nm, c =0.46 nm). The corresponding selected-area electron diffraction (SAED) patterns (Fig. 2d) further confirmed the presence of the single crystalline Ni₃S₂ nanorods and polycrystalline Ni(OH)₂ nanosheets. In addition, the energy dispersive X-ray spectrometry (EDS) analysis was conducted to confirm the composition of Ni₃S₂@Ni(OH)₂ (Fig. 2e). The elements, Cu (from the copper TEM grid), Ni, S and O were all detected. The EDS mapping (Fig. 2f) clearly shows that the strongest signals for Ni and S were found in the backbone region, whereas only Ni and O signals were observed in the shell region, confirming the Ni₃S₂@Ni(OH)₂ core–shell hierarchical structure.

Raman spectroscopy was used to further characterize the synthesized Ni₃S₂@Ni(OH)₂/3DGN. Fig. 3 shows the typical G (~1580 cm⁻¹) and 2D (~2732 cm⁻¹) peaks that are characteristic of graphene in the 3DGN (curve a). The integrated peak area ratio of the 2D band to G band (~0.51) indicates that the 3D graphene network contains few-layer graphene.^{25,26} The typical G (~1563 cm⁻¹) and 2D (~2706 cm⁻¹) peaks shown in curve b of Fig. 3 indicate that the graphene still existed after the synthesis of Ni₃S₂@Ni(OH)₂ on the 3DGN. In order to further confirm the presence of graphene, the Ni₂S₃@Ni(OH)₂ and Ni foam in Ni₃S₂@Ni(OH)₂/3DGN were removed by immersing





Fig. 3 Raman spectra of (a) the 3DGN and (b) the Ni₃S₂@Ni(OH)₂/3DGN.

Ni₃S₂@Ni(OH)₂/3DGN in a 1 M HCl aqueous solution at 60 °C overnight followed by rinsing with DI water several times. Fig. S1 (ESI[†]) indicates the 3DGN remained and 3D structure was still preserved, however some pores were observed on the surface of the graphene. In addition, two characteristic Raman peaks at ~537.6 cm⁻¹ (longitudinal optical, LO) and ~1090.7 cm⁻¹ (phonon modes, 2LO) were attributed to Ni(OH)₂ in Ni₃S₂@Ni(OH)₂/3DGN.^{28,29}

To investigate the morphological and structural evolution of the Ni₃S₂@Ni(OH)₂/3DGN, a series of experiments with different hydrothermal reaction times were conducted (Fig. 4a–c), which indicate the evolution of the structure from Ni_3S_2 nanorods to Ni_3S_2 (a)Ni(OH)₂, and then finally conversion to pure $Ni(OH)_2$ nanosheets. After a hydrothermal reaction time of 6 h, Ni₃S₂ nanorods were obtained (Fig. 4a). The XRD pattern revealed that the nanorods were of the pure spinel Ni₃S₂ phase (Fig. 4d). However, if the hydrothermal reaction was carried out for 12 h, thin nanosheets were observed on the surface of the Ni_3S_2 nanorods (Fig. 4b), which were confirmed to be $Ni(OH)_2$ using TEM, SAED patterns and the EDS spectrum as shown in Fig. 2. The $Ni(OH)_2$ nanosheets are connected to each other, forming a highly porous morphology. At a longer reaction time of 24 h, structures composed of Ni(OH)₂ nanosheets were observed (Fig. 4c) and the Ni₃S₂ nanorods had disappeared, which was also confirmed using TEM images (Fig. S2[†]). The absence of Ni₃S₂ peaks and the existence of Ni(OH)₂ (JCPDS no. 14-0117) peaks at $2\theta = 33$, 38.5 and 59° in the XRD spectrum (Fig. 4d) further confirmed that the Ni₃S₂ was transformed to $Ni(OH)_2$ after long reaction times (e.g. 24 h). Therefore, the Ni₃S₂ nanorods can be used as a sacrificial template for synthesizing the Ni₃S₂@Ni(OH)₂ hybrid structure using the hydrothermal reaction.

Based on the experimental results mentioned above, a possible growth mechanism for the $Ni_3S_2(Mi(OH)_2/3DGN)$ is proposed (Fig. 4e). It has been reported that graphene oxide can be etched by hydrothermal steaming at 200 °C, forming porous structures.³¹ Therefore, we believe that the 3DGN can also be partially destroyed or etched during our hydrothermal process.



Fig. 4 SEM images of the products obtained at different hydrothermal reaction times: (a) 6 h, (b) 12 h and (c) 24 h. Inset in (b): a magnified image of the Ni₃S₂@Ni(OH)₂/3DGN structure. (d) The XRD patterns of the samples shown in (a–c). (e) Proposed mechanism for the growth of the Ni₃S₂@Ni(OH)₂/3DGN structure.

In this case, some of the Ni foam could be exposed. Therefore, during the hydrothermal process, the active species (S ions) released from thioacetamide (TAA) react with the exposed Ni foam to form small Ni₃S₂ particles on the surface of the 3DGN after a reaction time of 2 h (Fig. S3a and b†). The morphology obtained is different from the original 3DGN (Fig. S3c†). At longer reaction times (*e.g.* 6 h), the Ni₃S₂ nanorods grow on the surface of the 3DGN (step A in Fig. 4a and e). When the reaction time is increased to 12 h, the Ni₃S₂ nanorods are hydrolyzed under the hydrothermal conditions and the Ni₃S₂ nanorod@Ni(OH)₂ nanosheet core–shell heterostructure is formed (step B in Fig. 4b and e). Finally, after a reaction time of 24 h, the Ni₃S₂ nanorods are completely transformed into Ni(OH)₂ nanosheets (step C in Fig. 4c and e).

Fig. 5a shows the cyclic voltammogram (CV) curves of the Ni₃S₂@Ni(OH)₂/3DGN, Ni₃S₂/3DGN, Ni(OH)₂/3DGN and Ni₃S₂@Ni(OH)₂/nickel foam (Ni₃S₂@Ni(OH)₂/Ni) recorded at a scan rate of 5 mV s⁻¹. All of the CV curves exhibit a pair of redox peaks, which are distinguishable from those of electric double-layer capacitors, implying the presence of a reversible Faradic reaction and pseudocapacitive behavior. The specific





Fig. 5 (a) Cyclic voltammograms of the Ni₃S₂@Ni(OH)₂/3DGN, Ni₃S₂/3DGN, Ni(OH)₂/3DGN and Ni₃S₂@Ni(OH)₂/Ni foam electrodes within the potential range of -0.15 to 0.55 V at a constant scan rate of 5 mV s⁻¹. (b) Cyclic voltammograms of the Ni₃S₂@Ni(OH)₂/3DGN at different scan rates of 2, 5, 10 and 20 mV s⁻¹. (c) Discharge curves for the Ni₃S₂@Ni(OH)₂/3DGN at various current densities. (d) Cycling stability of the Ni₃S₂/3DGN, Ni₃S₂@Ni(OH)₂/3DGN at a current density of 5.9 A g⁻¹. (e) The last 20 charge–discharge curves for the Ni₃S₂@Ni(OH)₂/3DGN. (f) Nyquist plots of the Ni₃S₂/3DGN, Ni₃S₂@Ni(OH)₂/3DGN and Ni(OH)₂/3DGN and Ni(OH)₂/3DGN and Ni(OH)₂/3DGN electrodes.

capacitance of the Ni₃S₂@Ni(OH)₂/3DGN, Ni(OH)₂/3DGN and Ni₃S₂/3DGN calculated from CV curves at 5 mV s⁻¹ were 1125, 981 and 340 F g⁻¹, respectively (for detailed calculations see the ESI†), which are higher than those of the composites directly grown on Ni foam without the 3DGN (*i.e.* Ni₃S₂@Ni(OH)₂/Ni, Ni₃S₂/Ni and Ni(OH)₂/Ni, Fig. S4†). This indicates that the 3DGN on the surface of the nickel foam plays an essential role in enhancing the supercapacitor performance. Importantly, the greatly enhanced electrochemical behavior of the Ni₃S₂@Ni(OH)₂/3DGN, compared with the Ni(OH)₂/3DGN and Ni₃S₂/3DGN, can be attributed to the synergistic effect resulting from the more active sites offered by the Ni(OH)₂ nanosheets and the quick electron transport of the highly crystalline Ni₃S₂ nanorods.^{6,32}

Fig. 5b shows the CV curves of the Ni₃S₂@Ni(OH)₂/3DGN at different scan rates. With the increase of scan rate, the current response increases accordingly and the shapes of CV curves are retained, indicating a good rate capability. The specific capacitance of the Ni₃S₂@Ni(OH)₂/3DGN calculated from the CV curve is 1277 F g⁻¹ at a scan rate of 2 mV s⁻¹ and 716 F g⁻¹ at a high scan rate of 20 mV s⁻¹ (Fig. S5a†). Fig. 5c shows the galvanostatic discharge curves of the Ni₃S₂@Ni(OH)₂/3DGN at different current densities. A high specific capacitance (1037.5 F g⁻¹) was obtained at a discharge current density of 5.1 A g⁻¹. Even at a relatively high current density of 19.8 A g⁻¹, a specific capacitance of 398 F g⁻¹ was obtained (Fig. S5b†). It should be noted that the aforementioned capacitance values of the composite electrodes (*e.g.* the Ni₃S₂@Ni(OH)₂/3DGN and Ni₃S₂@Ni(OH)₂/Ni) were calculated based on Ni₃S₂ (for detailed calculations, see the ESI†), since the exact mass ratio of Ni₃S₂ and Ni(OH)₂ is difficult to determine. Therefore, the actual capacitance value of the Ni₃S₂@Ni(OH)₂/3DGN structure should be higher than the aforementioned value, *e.g.* 1724 F g⁻¹ at 2 mV s⁻¹ and 1402 F g⁻¹ at 5.1 A g⁻¹ are the calculated values based on Ni(OH)₂ (Fig. S5†).

The cycling performances of the Ni₃S₂(@Ni(OH)₂/3DGN, $Ni(OH)_2/3DGN$ and $Ni_3S_2/3DGN$ at a current density of 5.9 A g⁻¹ are shown in Fig. 5d. At this current density, the specific capacitance of 981 F g^{-1} (99.1% of the initial value of 1003 F g^{-1}), calculated based on the pure Ni₃S₂, can be maintained after 2000 cycles. The shape of the last 20 charge-discharge curves (Fig. 5e) and the morphology of Ni₃S₂(a)Ni(OH)₂ after 2000 cycles (Fig. S6[†]) are nearly unchanged, indicating the excellent cyclability of the Ni₃S₂@Ni(OH)₂/3DGN electrode. However, the Ni₃S₂/3DGN shows a relatively low specific capacitance of 177 F g^{-1} for the first cycle. The specific capacitance increased slightly in subsequent cycles, possibly due to the formation of Ni(OH)2 on the surface of the Ni3S2 nanorods while in the alkaline solution.^{33,34} While the Ni(OH)₂/3DGN possesses a specific capacitance of 903 F g^{-1} for the first chargedischarge cycle, its specific capacitance decreases to 704 F g^{-1} (78% of the initial value) after 1000 cycles. The relatively worse cycling performance of Ni(OH)₂ is similar to that seen in previous reports.^{29,30} Importantly, our Ni₃S₂@Ni(OH)₂/3DGN electrode shows higher specific capacitance than many of the previously reported composite electrodes including CoO@NiHON (798.3 F g^{-1} at 1.67 A g^{-1} , 95% maintained after 2000 cycles),⁹ NiS hollow sphere (927 F g^{-1} at 4.08 A g^{-1} , 70% maintained after 3000 cycles)¹⁵ and NiO/3D graphene (745 F g⁻¹ at 1.4 A g⁻¹, 100% maintained after 2000 cycles)²⁵ electrodes. In addition, electrochemical impedance spectroscopy (EIS) was also employed to characterize the composite electrodes (Fig. 5f). The equivalent series resistance (ESR) values of the Ni₃S₂/3DGN, Ni₃S₂@Ni(OH)₂/3DGN and Ni(OH)₂/3DGN are 1.07, 1.13 and 1.33 Ω , respectively, which are smaller than that reported for Ni(OH)2-coated nickel foam electrodes with high capacitive performance.35 Compared to the aforementioned 3DGN-based composites, Ni₃S₂@Ni(OH)₂/Ni has a higher ESR value (4.57 Ω), indicating that the 3DGN improved the charge transport properties of the composite electrodes (Fig. S4d[†]).

Fabrication of electrodes with high mass loading of active materials has practical significance in supercapacitor devices.^{36,37} However, the increase in loading density often results in a decrease of the performance of these electrochemical devices.³⁸ Fortunately, our Ni₃S₂@Ni(OH)₂/3DGN electrode with a high loading density (\sim 3.7 mg cm⁻²) still exhibits excellent supercapacitor performance as mentioned above. Moreover, the high areal capacitance of the Ni₃S₂@Ni(OH)₂/3DGN is 4.7 F cm⁻² at 2 mV s⁻¹ and 3.85 F cm⁻² at 19.1 mA cm⁻² (Fig. S5†), which is much better than the reported values for materials based on Co₃O₄@MnO₂ (0.56 F cm⁻² at 11.25 mA cm⁻²),⁶ MnO₂/carbon nanotubes (2.8 F cm⁻²

at 0.05 mV s⁻¹)³⁸ and Co₃O₄/NiO (2.56 F cm⁻² at 2 A g⁻¹).³⁹ To further evaluate the performance of the Ni₃S₂@Ni(OH)₂/3DGN electrode, the energy density (*E*) and power density (*P*) were calculated from the charge–discharge curves (see the ESI† for the details). The Ni₃S₂@Ni(OH)₂/3DGN gave a high energy density of 70.6 Wh kg⁻¹ at a power density of 1.3 kW kg⁻¹, and still retains a value of 27.1 Wh kg⁻¹ at a power density of 5 kW kg⁻¹ (Fig. S7†).

The aforementioned results reveal the high specific capacitance, remarkable rate capability as well as excellent cycling performance of the Ni₃S₂(@Ni(OH)₂/3DGN when used as high-performance electrochemical pseudocapacitors. Such superior performance of the Ni₃S₂(a)Ni(OH)₂/3DGN can be attributed to the following factors. First, the CVD grown 3DGN on nickel foam with a high surface area and high electrical conductivity can effectively collect and transfer charges.25,27 Second, the Ni(OH)₂ nanosheets possess a high contact area with the electrolyte, thus enabling fast and reversible redox reactions, which improve the specific capacitance.9,35 Third, the single-crystal Ni₃S₂ nanorod array grown on the surface of the 3DGN provides large open spaces and a shorter ion diffusion path, which avoid the use of a polymer binder or conductive additive in the electrode materials.6,40 Importantly, Ni3S2 has a heazlewoodite structure with short metal-metal distances in an approximately body-centred cubic sulphur lattice, which results in it having good electrical properties³³ and enables the quick transport of electrons along the Ni3S2 nanorods. In addition, the one-step synthesized Ni₃S₂(@Ni(OH)₂ core-shell nanostructures on the 3DGN aids the electron transfer between the Ni(OH)₂, Ni₃S₂ and 3DGN components due to the perfect interface connection between them.

Conclusions

In summary, the large-amount Ni₃S₂@Ni(OH)₂/3DGN, *i.e.* Ni(OH)₂ nanosheets coated on the single-crystal Ni₃S₂ nanorods grown on the surface of 3D graphene network, is synthesized by a simple one-step hydrothermal reaction. By controlling the reaction time, different composites and nanostructures, *i.e.*, Ni₃S₂/3DGN, Ni₃S₂@Ni(OH)₂/3DGN and Ni(OH)₂/3DGN, are obtained. Detailed electrochemical characterization shows that the Ni₃S₂@Ni(OH)₂/3DGN exhibits high specific capacitance (1277 F g⁻¹ at 2 mV s⁻¹ and 1037.5 F g⁻¹ at 5.1 A g⁻¹) and areal capacitance (4.7 F cm⁻² at 2 mV s⁻¹ and 3.85 F cm⁻² at 19.1 mA cm⁻²) with good cycling performance (99.1% capacitance retention after 2000 cycles). The enhanced supercapacitor performance might arise from the synergistic effect between the Ni(OH)₂ nanosheets, Ni₃S₂ nanorods and 3D graphene network.

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